DRAWINGS

- FIG. 1
- FIG. 2
- FIG. 3
- FIG. 4
- WAFER COMMENCEMENT
- SURFACE OXIDATION
- PROCESS 2
- PROCESS 3
- PROCESS n
- PROCESS n+1
- FINAL PROCESS
- 30 THIN FILM DEPOSITION
- 31 RESIST COATING
- 32 EXPOSURE
- 33 DEVELOPING
- 34 ETCHING
- 35 RESIST STRIPPING
- 36 CLEANING
- 37, 38, 39 VISUAL CHECK

```
FIG. 5
```

(a)

NORMAL

FAILURE RATE BELOW 50%

FAILURE RATE OVER 50%

CHIP A, CHIP B, CHIP C, CHIP D

(b)

TYPICAL BRIGHINESS VALLUE OF WINDOW PATTERNS

CHIP A, CHIP B, CHIP C, CHIP D

NORMAL

COORDINATES OF CHIPS

(c)

OCCURRENCE PROBABILITY

TYPICAL BRIGHTNESS VALUE

FIG. 7

SIGNAL AMOUNT

NORMAL LEVEL

CONTACT RESISTANCE

FIG. 8

NORMAL

FAILURE RATE BELOW 50%

FAILURE RATE OVER 50%

FIG. 9

FIG. 10

FIG. 11

FIG. 12

(b)

BRIGHTNESS

COODINATES WITHIC IMAGES

(c)

FREQUENCY

BRIGHINESS

FIG. 13

(b)

BRIGHINESS

COORDINATES WITHIN IMAGES

(c)

BRIGHTNESS

COORDINATES WITHIN IMAGES

(a)

LOW PATTERN DENSITY

HIGH PATTERN DENSITY

FIG. 15

(b)

BRIGHINESS

COORDINATES WITHIN IMAGES

FIG. 16

FIG. 17

BRIGHTNESS OF PATTENS

ETCHING TIME

FIG. 18

FREQUENCY

BRIGHINESS

FIG. 19

124 COLUMN CONTROLLER

125 STAGE CONTROLLER

126 IMAGE PROCESSING UNIT

127 GENERAL CONTROLLING UNIT

128 OPERATOR.

- 131 PROCESS MANAGEMENT SYSTEM
- 133 FAILURE ANALYSIS SYSTEM

- 127 GENERAL CONTROL UNIT
- 128 OPERATOR
- 131 PROCESS CONTROL SYSTEM
- 133 FAILURE ANALYSIS SYSTEM
- 134 CRITICAL DIMENSION MEASUREMENT SEM, FIB, ELECTRON-BEAM

INSPECTION APPARATUS, REVIEW SEM

EXTERNAL INTERFACE

IMAGE PROCESSING SYSTEM

FIG. 21

(a)

BRIGHINESS OF PATTERN SECTIONS

LOT # (INSPECTING ORDER)

(b)

BRIGHTNESS OF PATTERN SECTIONS

TIME AND DATE OF COMMENCEMENT

(c)

BRIGHTNESS OF PATTERN SECTIONS

TIME AND DATE OF COMMENCEMENT

DRAWINGS

FIG. 1

FIG. 2

FIG. 3

FIG. 4

COMMENCEMENT OF PROCESSING A WAFER

SURFACE OXIDATION

PROCESS 2

PROCESS 3

PROCESS n

PROCESS n+1

FINAL PROCESS

- 30 THIN FILM DEPOSITION
- 31 RESIST COATING
- 32 EXPOSURE
- 33 DEVELOPING
- 34 ETCHING
- 35 RESIST STRIPPING
- 36 CLEANING
- 37, 38, 39 VISUAL INSPECTION

FIG. 6

(a) ·

NORMAL

FAILURE RATE UNDER 50%

FAILURE RATE OVER 50%

CHIP A, CHIP B, CHIP C, CHIP D

(b)

TYPICAL BRIGHTNESS VALLUE OF HOLE PATTERNS

CHIP A, CHIP B, CHIP C, CHIP D

NORMAL

COORDINATES OF CHIPS

(c)

OCCURRENCE PROBABILITY

TYPICAL BRIGHTNESS VALUE

FIG. 7

SIGNAL AMOUNT

NORMAL LEVEL

CONTACT RESISTANCE

FIG. 8

NORMAL

FAILURE RATE UNDER 50%

FAILURE RATE OVER 50%

FIG. 9

FIG. 10

FIG. 11

FIG. 12

(b)

BRIGHINESS

COODINATES IN THE IMAGES

(c)

FREQUENCY

BRIGHINESS

FIG. 13

(b)

BRIGHTNESS

COORDINATES IN THE IMAGES

(c)

BRIGHINESS

COORDINATES IN THE IMAGES

(a)

LOW PATTERN DENSITY

HIGH PATTERN DENSITY

FIG. 15

(b)

BRIGHTNESS

COORDINATES IN THE IMAGES

FIG. 16

FIG. 17

BRIGHTNESS OF PATTENS

ETCHING TIME

FIG. 18

FREQUENCY

BRIGHINESS

FIG. 19

124 COLUMN CONTROLLER

125 STAGE CONTROLLER

126 IMAGE PROCESSING UNIT

127 GENERAL CONTROLLING UNIT

128 OPERATOR

- 131 PROCESS MANAGEMENT SYSTEM
- 133 FAILURE ANALYSIS SYSTEM

- 127 GENERAL CONTROL UNIT
- 128 OPERATOR
- 131 PROCESS CONTROL SYSTEM
- 133 FAILURE ANALYSIS SYSTEM
- 134 CRITICAL DIMENSION MEASUREMENT SEM, FIB, ELECTRON-BEAM INSPECTION APPARATUS, REVIEW SEM
- 135 EXTERNAL INTERFACE
- 136 IMAGE PROCESSING SYSTEM

FIG. 21

(a)

BRIGHTNESS OF PATTERN SECTIONS

LOT # (INSPECTING ORDER)

(b)

BRIGHTNESS OF PATTERN SECTIONS

TIME AND DATE OF COMMENCEMENT

(c)

BRIGHINESS OF PATTERN SECTIONS

TIME AND DATE OF COMMENCEMENT

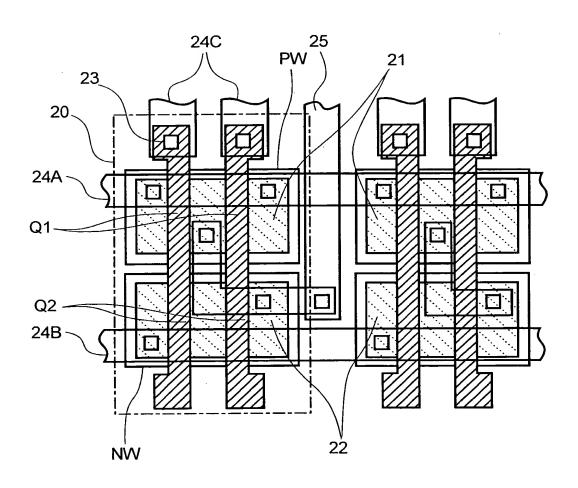


FIG.2

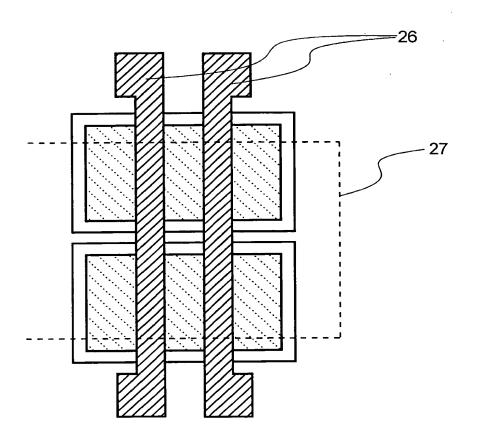


FIG.3

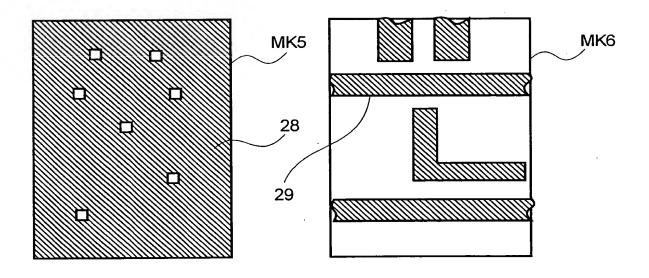


FIG.4

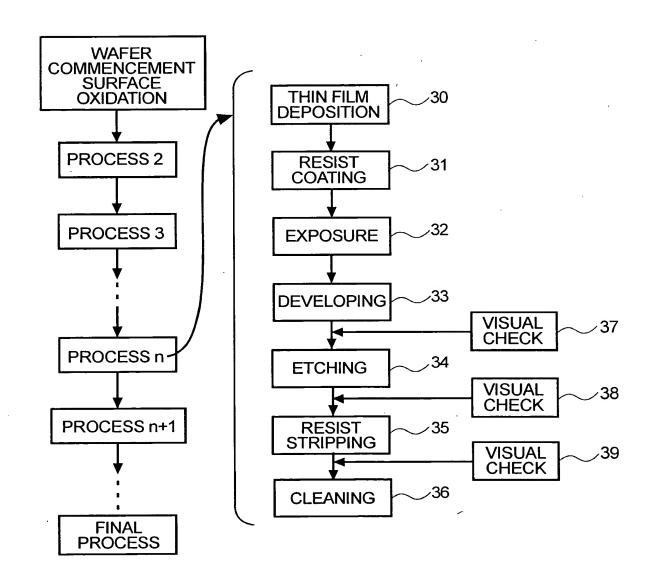


FIG.5

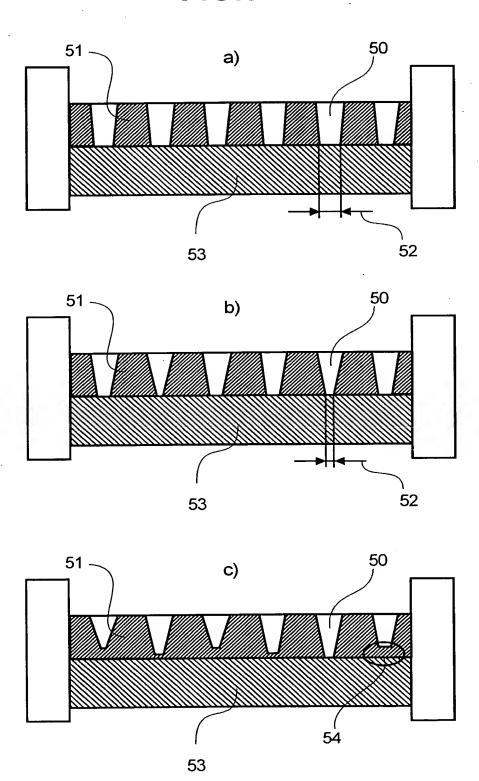
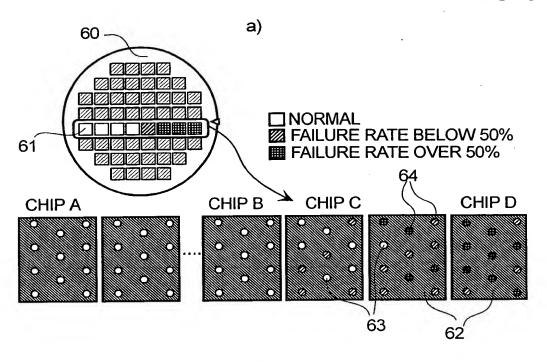
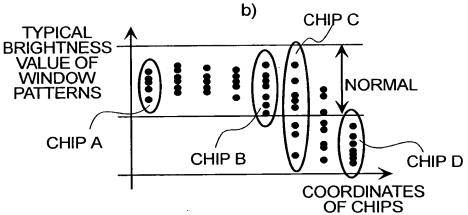


FIG.6





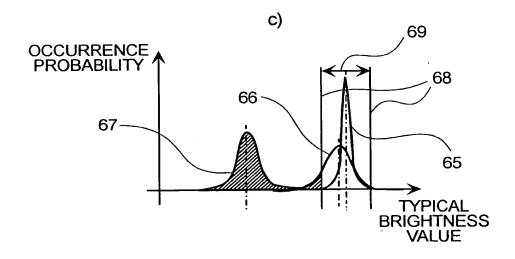


FIG.7

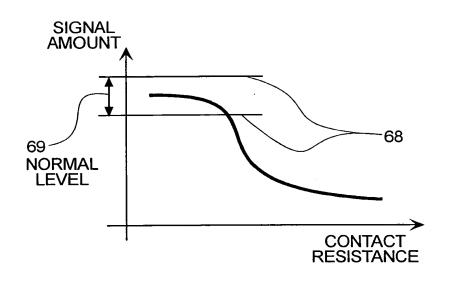


FIG.8

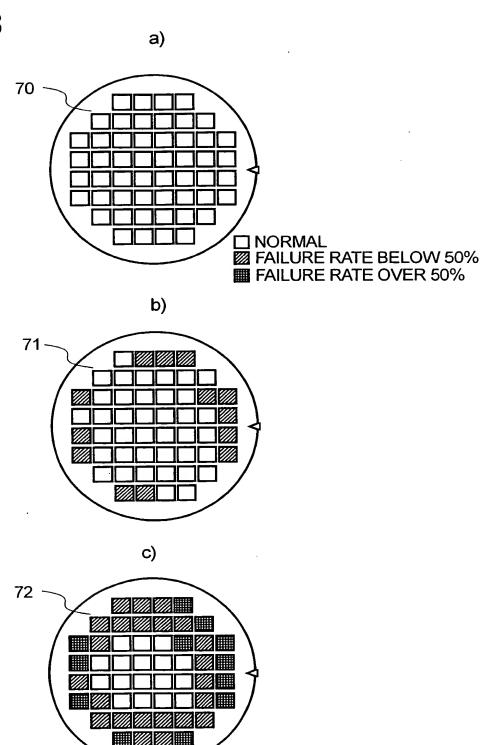


FIG.9

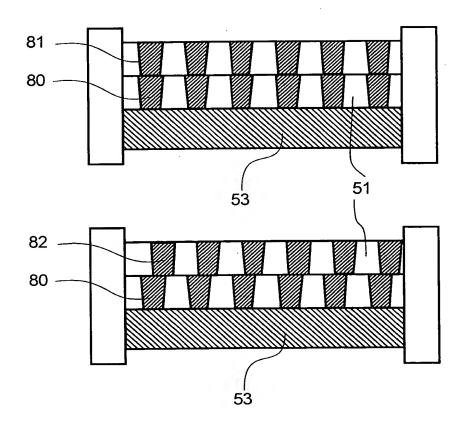


FIG.10

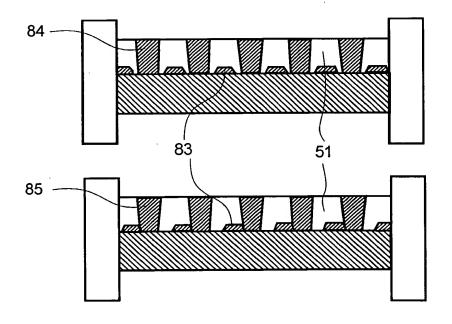


FIG.11

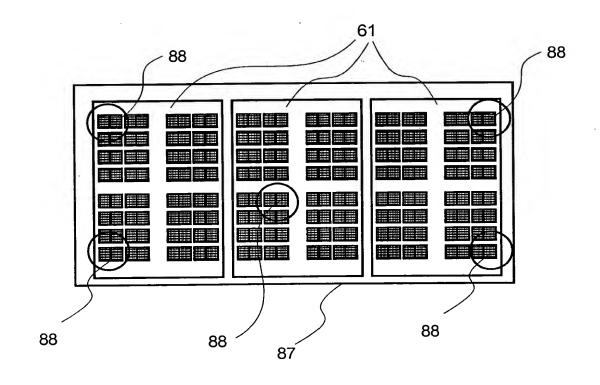


FIG.12

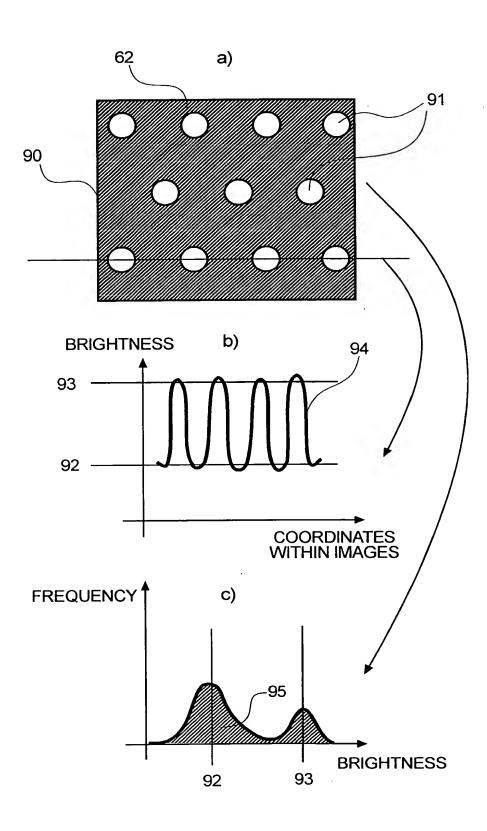
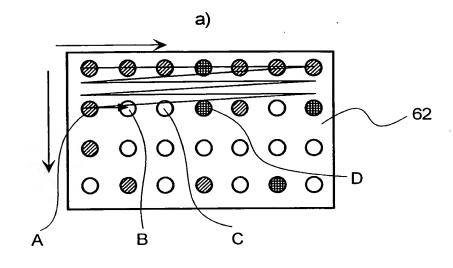
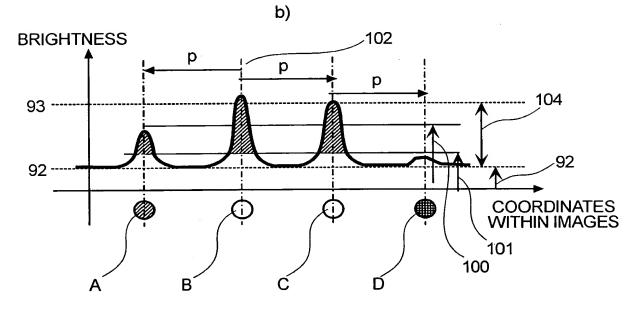
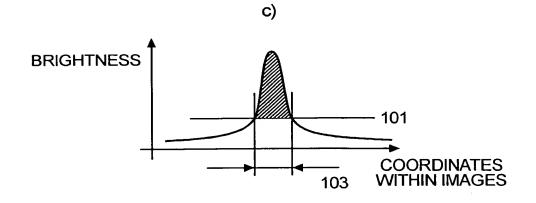


FIG.13







a) LOW PATTERN DENSITY

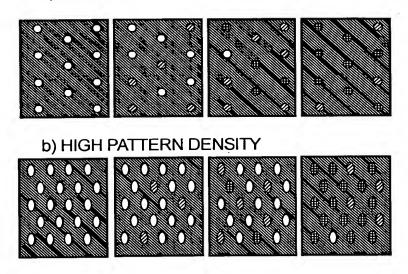


FIG.15

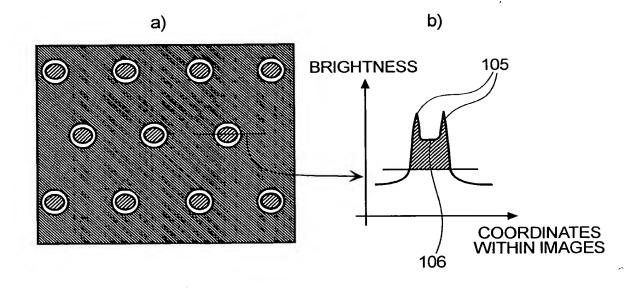


FIG.16

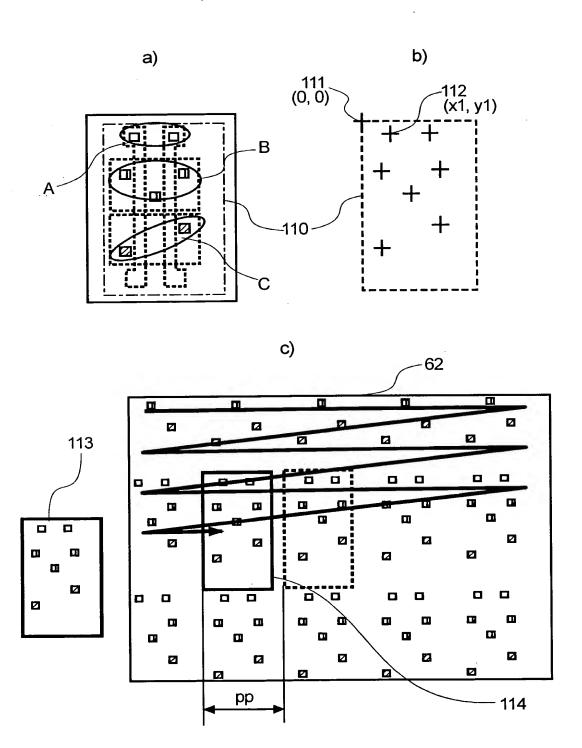


FIG.17

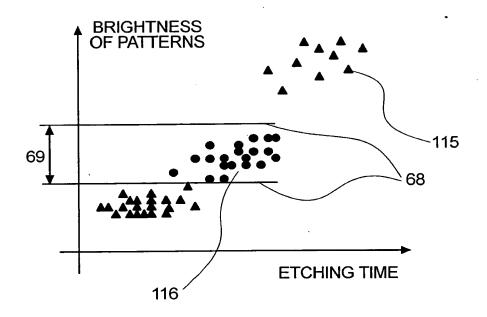


FIG.18

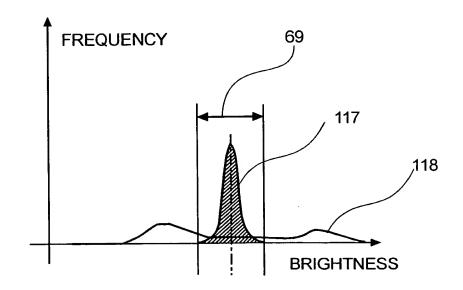


FIG.19

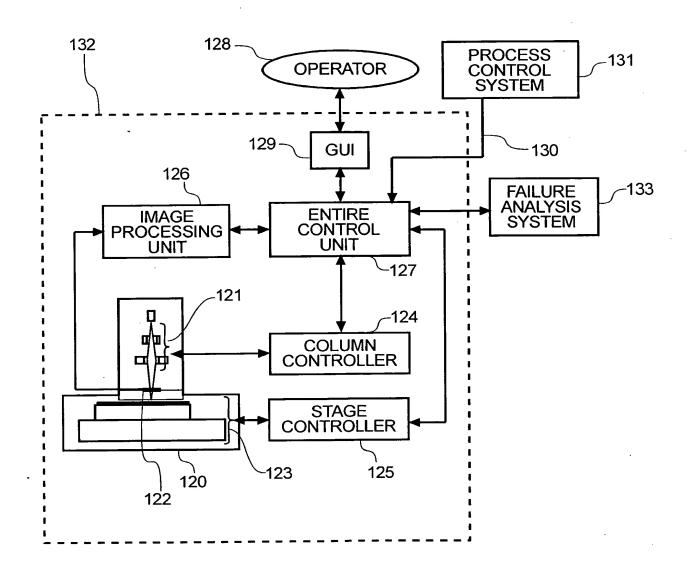
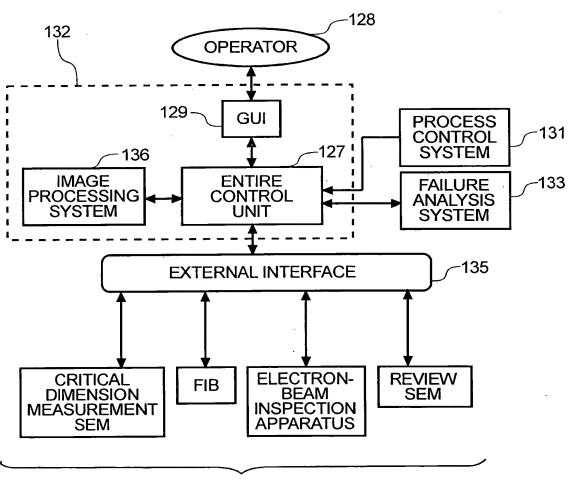


FIG.20



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